



# PHP29N08T

## N-channel TrenchMOS standard level FET

Rev. 02 — 12 March 2009

Product data sheet

## 1. Product profile

### 1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

### 1.2 Features and benefits

- High noise immunity due to high gate threshold voltage
- Low conduction losses due to low on-state resistance

### 1.3 Applications

- Industrial motor control

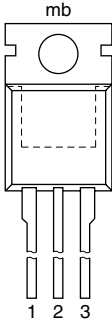
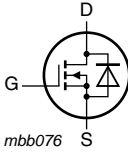
### 1.4 Quick reference data

Table 1. Quick reference

| Symbol                         | Parameter                        | Conditions   | Min | Typ | Max | Unit       |
|--------------------------------|----------------------------------|--|-----|-----|-----|------------|
| $V_{DS}$                       | drain-source voltage             | $T_j \geq 25\text{ °C}; T_j \leq 175\text{ °C}$  | -   | -   | 75  | V          |
| $I_D$                          | drain current                    | $T_{mb} = 25\text{ °C}; V_{GS} = 11\text{ V};$<br>see <a href="#">Figure 1</a> ; see <a href="#">Figure 3</a>                        | -   | -   | 27  | A          |
| $P_{tot}$                      | total power dissipation          | $T_{mb} = 25\text{ °C};$ see <a href="#">Figure 2</a>  | -   | -   | 88  | W          |
| <b>Dynamic characteristics</b> |                                  |  |     |     |     |            |
| $Q_{GD}$                       | gate-drain charge                | $V_{GS} = 10\text{ V}; I_D = 29\text{ A};$<br>$V_{DS} = 60\text{ V}; T_j = 25\text{ °C};$<br>see <a href="#">Figure 11</a>           | -   | 9   | -   | nC         |
| <b>Static characteristics</b>  |                                  |  |     |     |     |            |
| $R_{DS(on)}$                   | drain-source on-state resistance | $V_{GS} = 11\text{ V}; I_D = 14\text{ A};$<br>$T_j = 175\text{ °C};$ see <a href="#">Figure 9</a> ;<br>see <a href="#">Figure 10</a> | -   | 96  | 120 | m $\Omega$ |
|                                |                                  | $V_{GS} = 11\text{ V}; I_D = 14\text{ A};$<br>$T_j = 25\text{ °C};$ see <a href="#">Figure 9</a> ;<br>see <a href="#">Figure 10</a>  | -   | 40  | 50  | m $\Omega$ |

## 2. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description                       | Simplified outline   | Graphic symbol  |
|-----|--------|-----------------------------------|--|---|
| 1   | G      | gate                              |  |  |
| 2   | D      | drain                             |  |   |
| 3   | S      | source                            |  |   |
| mb  | D      | mounting base, connected to drain |  |   |

**SOT78**  
(TO-220AB; SC-46)

## 3. Ordering information

**Table 3. Ordering information**

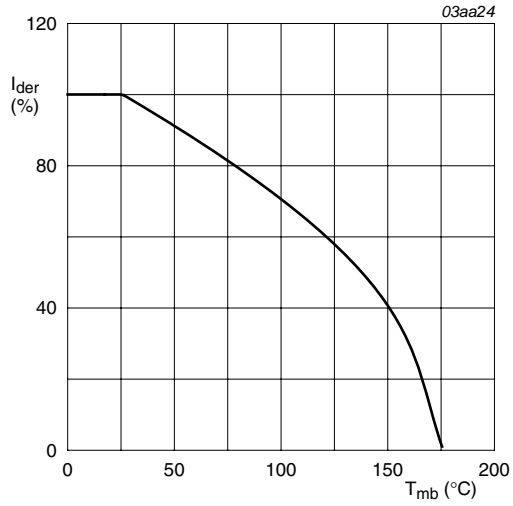
| Type number | Package            |   | Version |
|-------------|--------------------|---|---------|
|             | Name               | Description   |         |
| PHP29N08T   | TO-220AB;<br>SC-46 | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead<br>TO-220AB | SOT78   |

## 4. Limiting values

**Table 4. Limiting values**

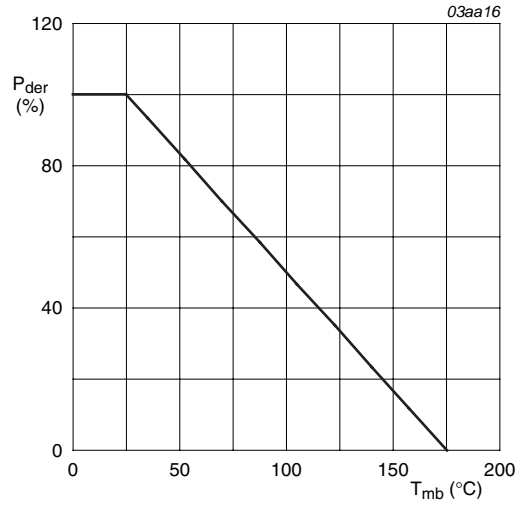
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                    | Parameter               | Conditions  | Min | Max  | Unit |
|---------------------------|-------------------------|---|-----|------|------|
| $V_{DS}$                  | drain-source voltage    | $T_j \geq 25\text{ °C}$ ; $T_j \leq 175\text{ °C}$  | -   | 75   | V    |
| $V_{DGR}$                 | drain-gate voltage      | $T_j \leq 175\text{ °C}$ ; $T_j \geq 25\text{ °C}$ ; $R_{GS} = 20\text{ k}\Omega$                                 | -   | 75   | V    |
| $V_{GS}$                  | gate-source voltage     |   | -30 | 30   | V    |
| $I_D$                     | drain current           | $V_{GS} = 11\text{ V}$ ; $T_{mb} = 100\text{ °C}$ ; see <a href="#">Figure 1</a>                                  | -   | 19.2 | A    |
|                           |                         | $V_{GS} = 11\text{ V}$ ; $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 1</a> ;<br>see <a href="#">Figure 3</a> | -   | 27   | A    |
| $I_{DM}$                  | peak drain current      | $t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 3</a>                 | -   | 108  | A    |
| $P_{tot}$                 | total power dissipation | $T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 2</a>  | -   | 88   | W    |
| $T_{stg}$                 | storage temperature     |   | -55 | 175  | °C   |
| $T_j$                     | junction temperature    |   | -55 | 175  | °C   |
| <b>Source-drain diode</b> |                         |   |     |      |      |
| $I_S$                     | source current          | $T_{mb} = 25\text{ °C}$   | -   | 27   | A    |
| $I_{SM}$                  | peak source current     | $t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; $T_{mb} = 25\text{ °C}$  | -   | 108  | A    |



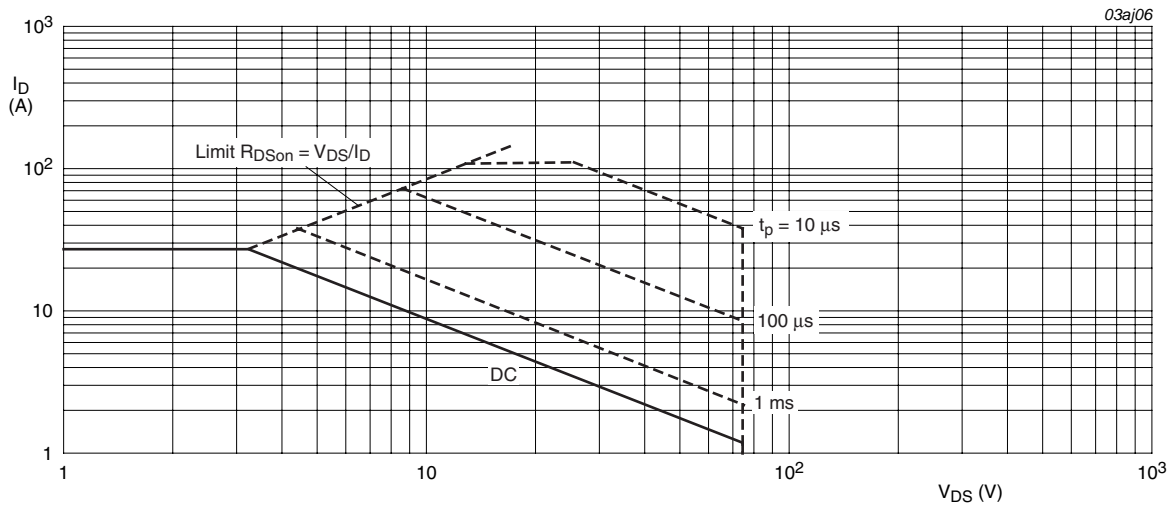
$$I_{der} = \frac{I_D}{I_{D(25^\circ\text{C})}} \times 100\%$$

Fig 1. Normalized continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ\text{C})}} \times 100\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



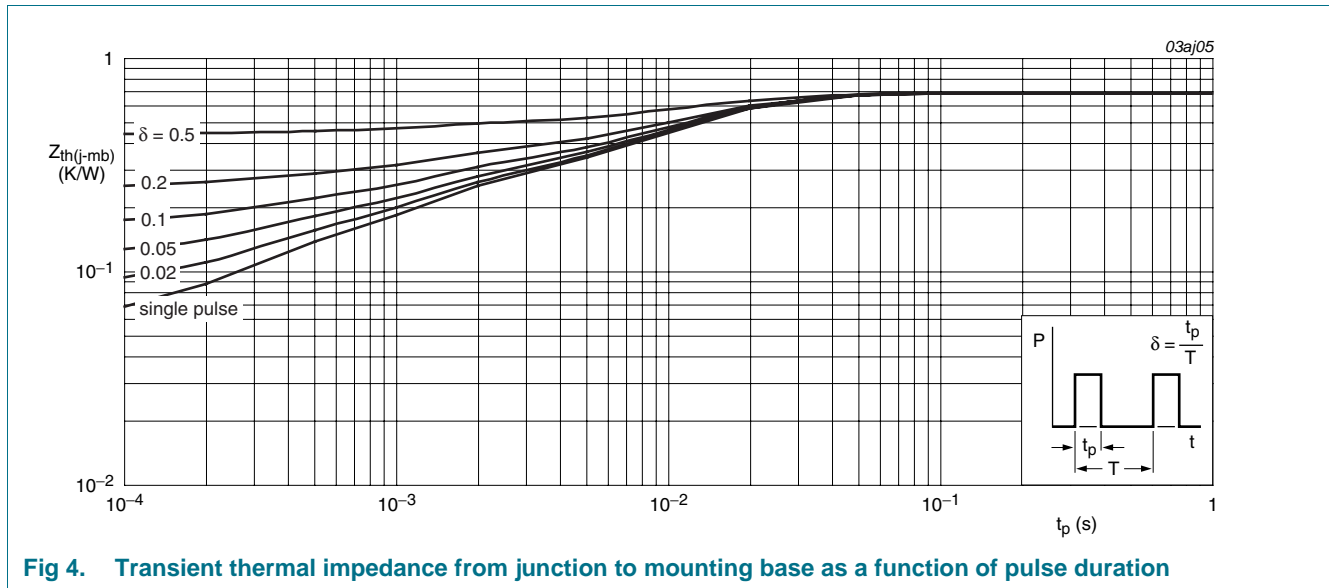
$T_{mb} = 25^\circ\text{C}; I_{DM}$  is single pulse;  $V_{GS} = 11\text{V}$

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

| Symbol         | Parameter   | Conditions                   | Min | Typ | Max | Unit |
|----------------|---|------------------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see <a href="#">Figure 4</a> | -   | -   | 1.7 | K/W  |
| $R_{th(j-a)}$  | thermal resistance from junction to ambient       | vertical in still air        | -   | 60  | -   | K/W  |

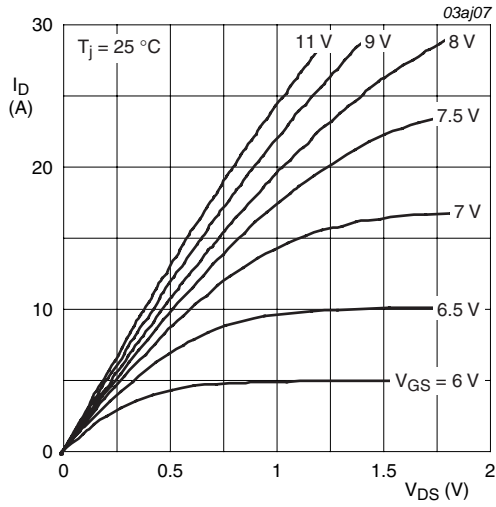


**Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration**

## 6. Characteristics

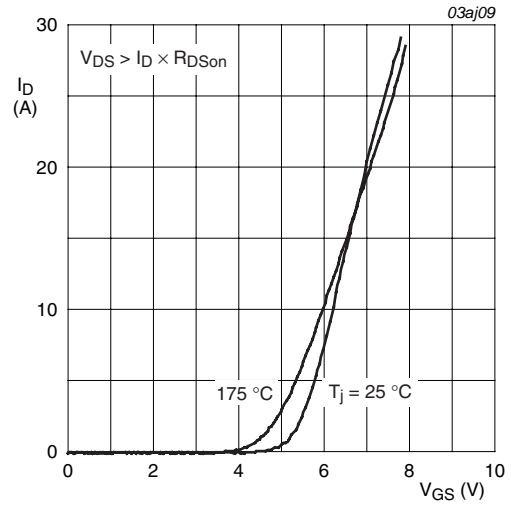
**Table 6. Characteristics**

| Symbol                         | Parameter                        | Conditions  | Min | Typ  | Max | Unit          |
|--------------------------------|----------------------------------|---|-----|------|-----|---------------|
| <b>Static characteristics</b>  |                                  |   |     |      |     |               |
| $V_{(BR)DSS}$                  | drain-source breakdown voltage   | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ }^\circ\text{C}$   | 70  | -    | -   | V             |
|                                |                                  | $I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | 75  | -    | -   | V             |
| $V_{GS(th)}$                   | gate-source threshold voltage    | $I_D = 2 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 8</a>  | 2.1 | -    | -   | V             |
|                                |                                  | $I_D = 2 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 8</a>  | -   | -    | 5.4 | V             |
|                                |                                  | $I_D = 2 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 8</a>   | 3   | 4    | 5   | V             |
| $I_{DSS}$                      | drain leakage current            | $V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | -   | 0.05 | 10  | $\mu\text{A}$ |
|                                |                                  | $V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ }^\circ\text{C}$   | -   | -    | 500 | $\mu\text{A}$ |
| $I_{GSS}$                      | gate leakage current             | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$  | -   | 10   | 100 | nA            |
|                                |                                  | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$   | -   | 10   | 100 | nA            |
| $R_{DS(on)}$                   | drain-source on-state resistance | $V_{GS} = 11 \text{ V}; I_D = 14 \text{ A}; T_j = 175 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 9</a> ; see <a href="#">Figure 10</a>                        | -   | 96   | 120 | m $\Omega$    |
|                                |                                  | $V_{GS} = 11 \text{ V}; I_D = 14 \text{ A}; T_j = 25 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 9</a> ; see <a href="#">Figure 10</a>                         | -   | 40   | 50  | m $\Omega$    |
| <b>Dynamic characteristics</b> |                                  |   |     |      |     |               |
| $Q_{G(tot)}$                   | total gate charge                | $I_D = 29 \text{ A}; V_{DS} = 60 \text{ V}; V_{GS} = 10 \text{ V};$<br>$T_j = 25 \text{ }^\circ\text{C};$ see <a href="#">Figure 11</a>                               | -   | 19   | -   | nC            |
| $Q_{GS}$                       | gate-source charge               |   | -   | 6    | -   | nC            |
| $Q_{GD}$                       | gate-drain charge                |   | -   | 9    | -   | nC            |
| $C_{iss}$                      | input capacitance                | $V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$<br>$T_j = 25 \text{ }^\circ\text{C};$ see <a href="#">Figure 12</a>                                 | -   | 810  | -   | pF            |
| $C_{oss}$                      | output capacitance               |   | -   | 140  | -   | pF            |
| $C_{rss}$                      | reverse transfer capacitance     |   | -   | 85   | -   | pF            |
| $t_{d(on)}$                    | turn-on delay time               | $V_{DS} = 38 \text{ V}; R_L = 1.3 \text{ } \Omega; V_{GS} = 10 \text{ V};$<br>$R_{G(ext)} = 5.6 \text{ } \Omega; T_j = 25 \text{ }^\circ\text{C}; I_D = 29 \text{ A}$ | -   | 9.5  | -   | ns            |
| $t_r$                          | rise time                        |   | -   | 70   | -   | ns            |
| $t_{d(off)}$                   | turn-off delay time              |   | -   | 15   | -   | ns            |
| $t_f$                          | fall time                        |   | -   | 9    | -   | ns            |
| <b>Source-drain diode</b>      |                                  |   |     |      |     |               |
| $V_{SD}$                       | source-drain voltage             | $I_S = 14 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C};$<br>see <a href="#">Figure 13</a>   | -   | 0.95 | 1.2 | V             |
| $t_{rr}$                       | reverse recovery time            | $I_S = 14 \text{ A}; di_S/dt = -100 \text{ A}/\mu\text{s}; V_{GS} = 0 \text{ V};$<br>$V_{DS} = 25 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$                         | -   | 50   | -   | ns            |
| $Q_r$                          | recovered charge                 |   | -   | 65   | -   | nC            |



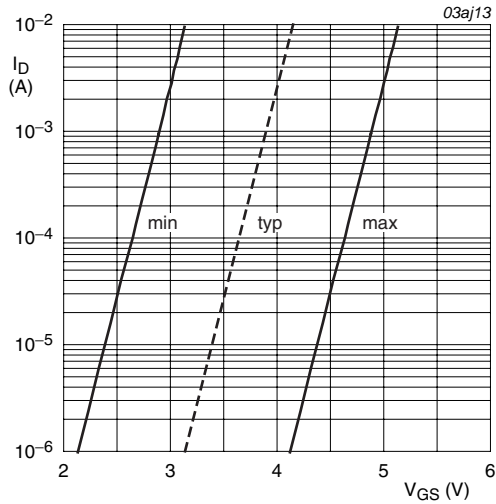
$T_j = 25^\circ\text{C}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



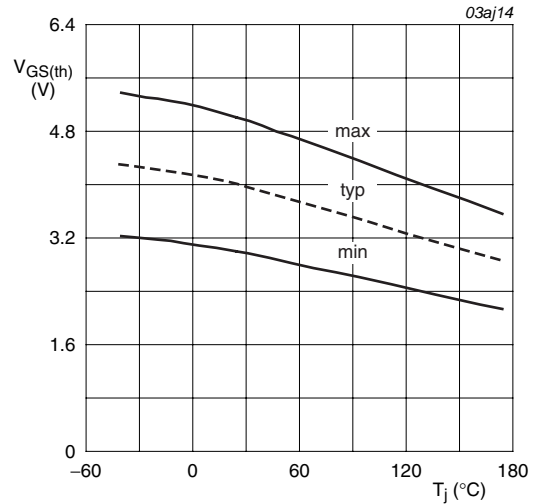
$T_j = 25^\circ\text{C}$  and  $175^\circ\text{C}; V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values



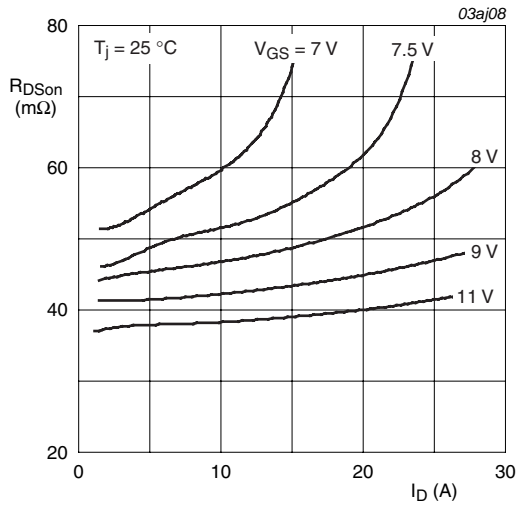
$T_j = 25^\circ\text{C}; V_{DS} = 10\text{V}$

Fig 7. Sub-threshold drain current as a function of gate-source voltage



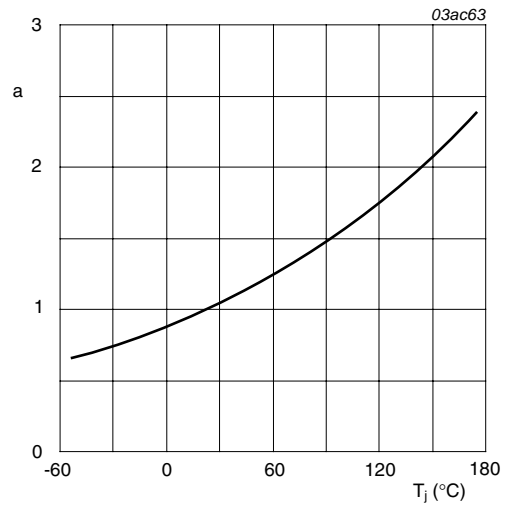
$I_D = 2\text{mA}; V_{DS} = V_{GS}$

Fig 8. Gate-source threshold voltage as a function of junction temperature



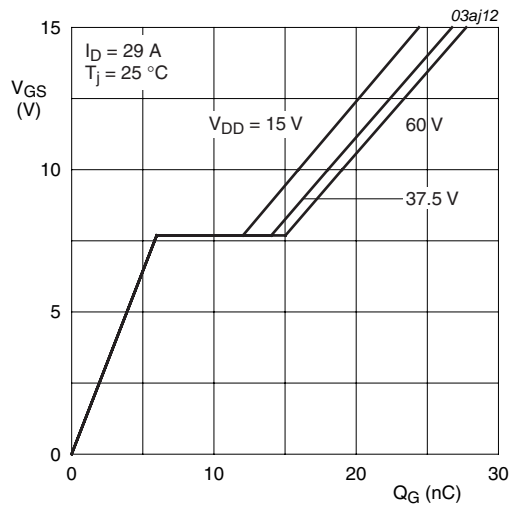
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$

Fig 9. Drain-source on-state resistance as a function of drain current; typical value



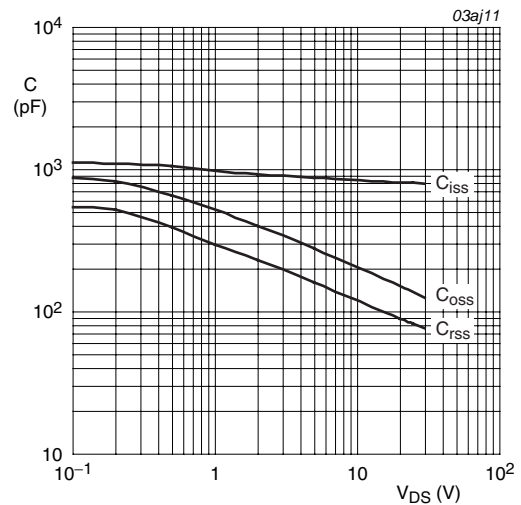
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$

Fig 10. Normalized drain-source on-state resistance factor as a function of junction temperature



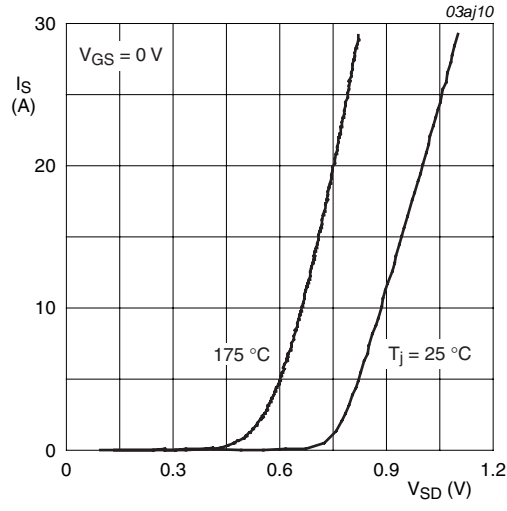
$$I_D = 29A; V_{DS} = 15V, 37.5V \text{ and } 60V$$

Fig 11. Gate-source voltage as a function of gate charge; typical values



$$V_{GS} = 0V; f = 1MHz$$

Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$T_j = 25^\circ C$  and  $175^\circ C; V_{GS} = 0V$

Fig 13. Source current as a function of source-drain voltage; typical values



## 7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78

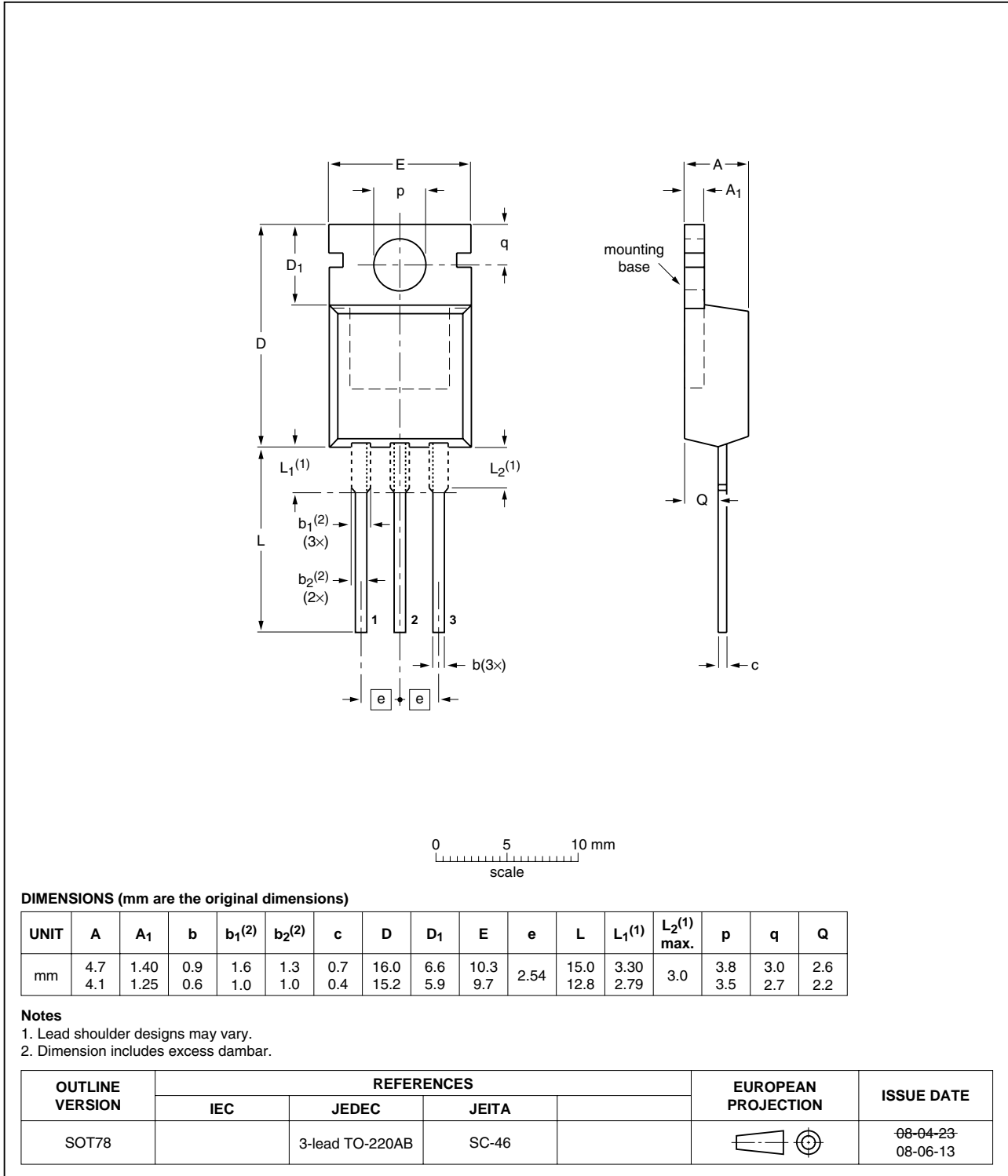


Fig 14. Package outline SOT78 (TO-220AB)

## 8. Revision history

Table 7. Revision history

| Document ID                          | Release date | Data sheet status  | Change notice | Supersedes       |
|--------------------------------------|--------------|--|---------------|------------------|
| PHP29N08T_2                          | 20090312     | Product data sheet   | -             | PHP_PHB29N08T-01 |
| Modifications:                       |              | <ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li><li>• Legal texts have been adapted to the new company name where appropriate.</li><li>• Type number PHP29N08T_2 separated from data sheet PHP_PHB29N08T-01.</li></ul> |               |                  |
| PHP_PHB29N08T-01<br>(9397 750 09651) | 20020529     | Product data   | -             | -                |

## 9. Legal information

### 9.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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